

### **Automotive MOSFET**

#### OptiMOS™ 7 Power-Transistor







#### **Features**

- OptiMOS<sup>™</sup> power MOSFET for automotive applications
- N-channel Enhancement mode Logic Level
- Extended qualification beyond AEC-Q101
- Enhanced electrical testing
- Robust design
- MSL1 up to 260°C peak reflow
- 175°C operating temperature
- RoHS compliant
- 100% Avalanche tested

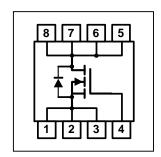
### **Potential applications**

General automotive applications.

#### **Product validation**

Qualified for automotive applications. Product validation according to AEC-Q101.





#### **Product Summary**

$V_{\mathrm{DS}}$	40	V
R <sub>DS(on)</sub>	1.13	mΩ
I <sub>D</sub> (chip limited)	222	Α

Туре	Package	Marking
IAUCN04S7L011	PG-TDSON-8-34	7N04L011

## IAUCN04S7L011



## **Table of Contents**

Description	· · · · · · · · · · · · · · · ·
Maximum ratings	
Thermal characteristics	
Electrical characteristics	
Electrical characteristics diagrams	
Package outline & footprint	10
Revision history	1
Disclaimor	1.

IAUCN04S7L011



# **Maximum ratings**

at Tj=25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	I <sub>D</sub>	V <sub>GS</sub> =10 V, Chip limitation <sup>1,2)</sup>	222	A
		V <sub>GS</sub> =10V, DC current	120	
		$T_a$ =100 °C, $V_{GS}$ =10 V, $R_{thJA}$ on 2s2p <sup>2,3)</sup>	36	
Pulsed drain current <sup>2)</sup>	/ <sub>D,pulse</sub>	T <sub>C</sub> =25 °C, t <sub>p</sub> = 100 μs	650	7
Avalanche energy, single pulse <sup>2)</sup>	E AS	/ <sub>D</sub> =54 A	98	mJ
Avalanche current, single pulse	I <sub>AS</sub>	-	108	А
Gate source voltage	V <sub>GS</sub>	-	±16	V
		limited to duty factor of 1%	+20	V
Power dissipation	P tot	Т <sub>С</sub> =25 °С	105	W
Operating and storage temperature	$T_{\rm j}$ , $T_{\rm stg}$	-	-55 +175	°C

IAUCN04S7L011



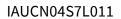
# Thermal characteristics<sup>2)</sup>

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Thermal resistance, junction - case	R thJC	-	-	0.7	1.4	K/W
Thermal resistance, junction - ambient <sup>3)</sup>	R <sub>thJA</sub>	-	-	27	-	

## **Electrical characteristics**

at Tj=25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Static characteristics						
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ =0 V, $I_{D}$ =1 mA	40	-	-	V
Gate threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 45 \mu A$	1.2	1.5	1.8	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{\rm DS}$ =40 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C	_	-	1	μΑ
		$V_{DS}$ =40 V, $V_{GS}$ =0 V, $T_{j}$ =100 °C <sup>2)</sup>	_	-	11	
Gate-source leakage current	I <sub>GSS</sub>	V <sub>GS</sub> =16 V, V <sub>DS</sub> =0 V	-	-	100	nA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =4.5 V, I <sub>D</sub> =60 A	_	1.39	1.63	mΩ
		V <sub>GS</sub> =10 V, I <sub>D</sub> =60 A	_	0.99	1.13	
Gate resistance <sup>2)</sup>	R <sub>G</sub>	-	_	2.1	_	Ω





Parameter	Symbol Conditions		Values			Unit
			min.	typ.	max.	]
Dynamic characteristics <sup>2)</sup>						
Input capacitance	C iss		-	3261	4240	pF
Output capacitance	C oss	$V_{GS}$ =0 V, $V_{DS}$ =20 V, $f$ =1 MHz	-	1636	2130	
Reverse transfer capacitance	C <sub>rss</sub>		-	57	85	1
Turn-on delay time	t d(on)		-	4	-	ns
Rise time	t <sub>r</sub>	$V_{\rm DD}$ =20 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =60 A,	-	3	-	
Turn-off delay time	t d(off)	$R_{\rm G}$ =3.5 $\Omega$	-	30	-	
Fall time	t f		_	15	-	
Gate to drain charge  Gate charge total	Q gs Q gd Q g	V <sub>DD</sub> =20 V, I <sub>D</sub> =60 A, V <sub>GS</sub> =0 to 10 V	-	9 8 49	11 13 64	nC
Gate charge total	Q <sub>g</sub>	V <sub>GS</sub> =0 to 10 V	-	49	64	
Gate plateau voltage	$V_{ m plateau}$		-	2.8	-	V
Reverse Diode						
Diode continous forward current <sup>2)</sup>	Is	т <sub>с</sub> =25 °С	ı	_	120	Α
Diode pulse current <sup>2)</sup>	I <sub>S,pulse</sub>	$T_{\rm C}$ =25 °C, $t_{\rm p}$ = 100 $\mu$ s	-	-	650	
Diode forward voltage	V <sub>SD</sub>	$V_{GS}$ =0 V, $I_{F}$ =60 A, $T_{j}$ =25 °C	ı	0.8	0.95	V
Reverse recovery time <sup>2)</sup>	t rr	V <sub>R</sub> =20 V, I <sub>F</sub> =50A,	-	34	51	ns
Reverse recovery charge <sup>2)</sup>	Q rr	$di_F/dt = 100 \text{ A/}\mu\text{s}$	-	21	41	nC

<sup>&</sup>lt;sup>1)</sup> Practically the current is limited by the overall system design including the customer-specific PCB.

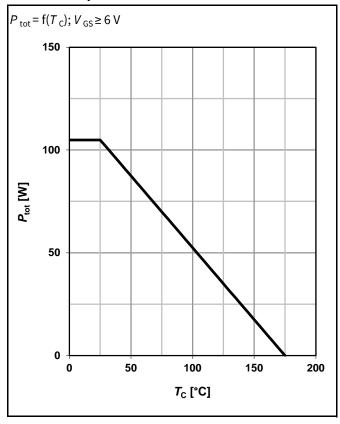
<sup>&</sup>lt;sup>2)</sup> The parameter is not subject to production testing – specified by design.

<sup>&</sup>lt;sup>3)</sup> Device on 2s2p FR4 PCB defined in accordance with JEDEC standards (JESD51-5, -7). PCB is vertical in still air.

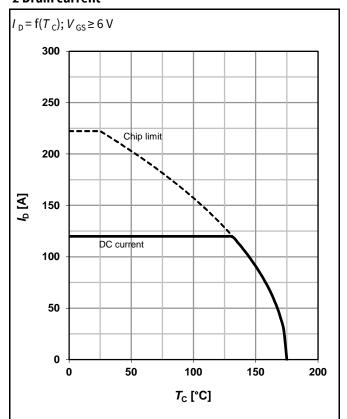


## **Electrical characteristics diagrams**

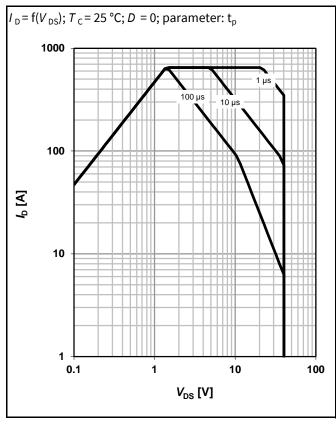
#### 1 Power dissipation



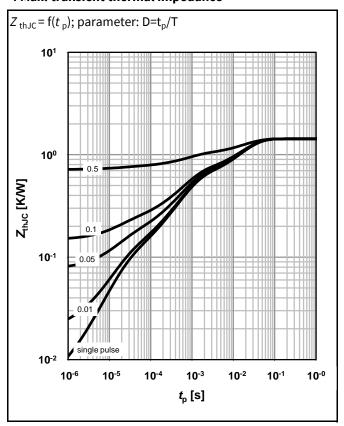
#### 2 Drain current



#### 3 Safe operating area



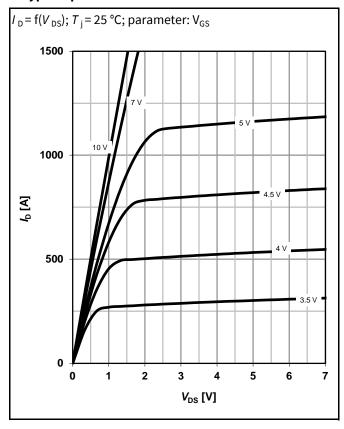
#### 4 Max. transient thermal impedance



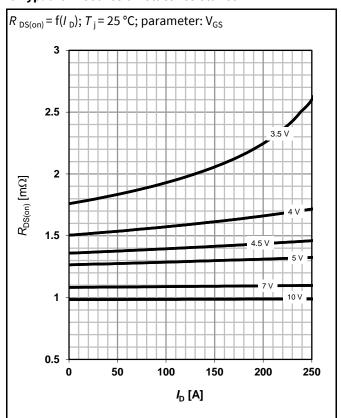
Rev. 1.0



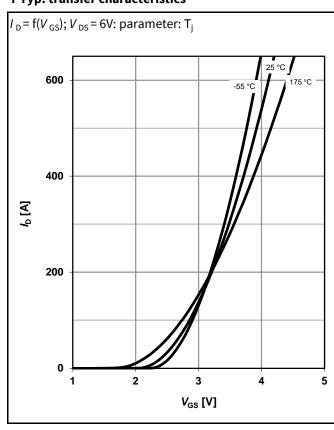
#### 5 Typ. output characteristics



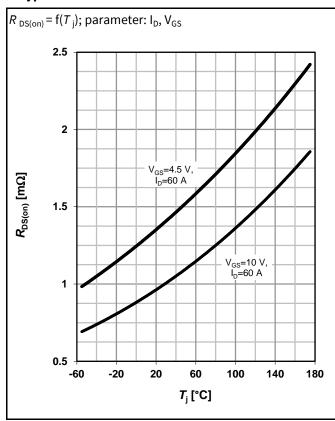
#### 6 Typ. drain-source on-state resistance



#### 7 Typ. transfer characteristics

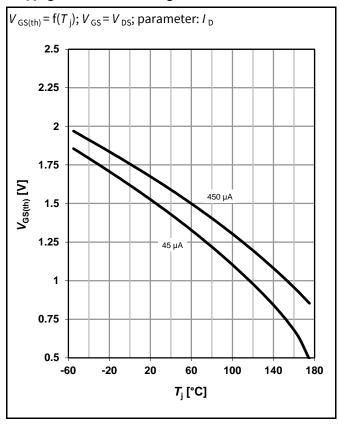


#### 8 Typ. drain-source on-state resistance

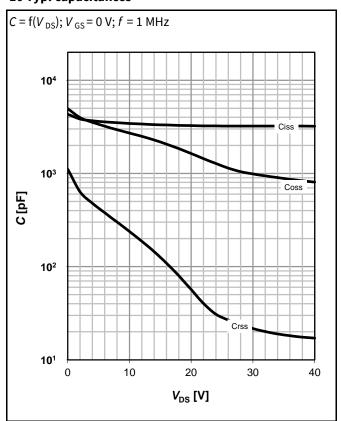


# **(infineon**

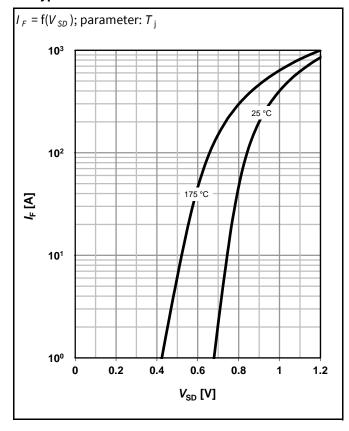
#### 9 Typ. gate threshold voltage



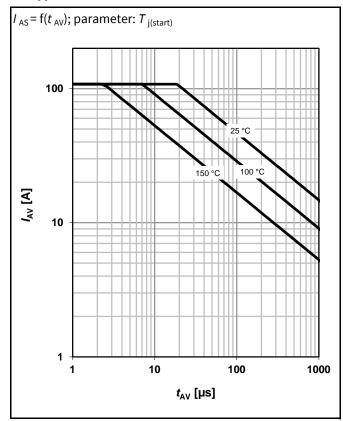
#### 10 Typ. capacitances



#### 11 Typical forward diode characteristics

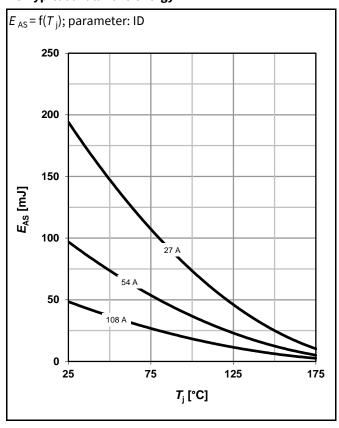


#### 12 Typ. avalanche characteristics

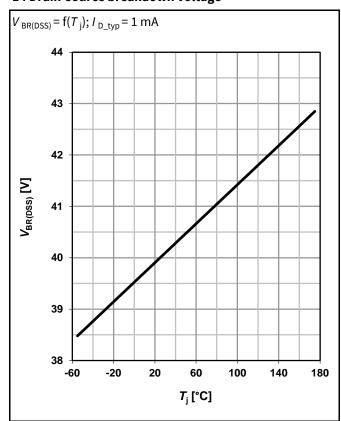


# **(infineon**

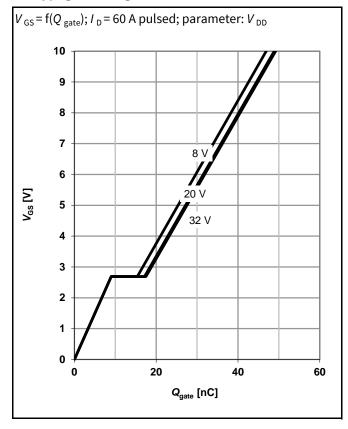
### 13 Typical avalanche energy



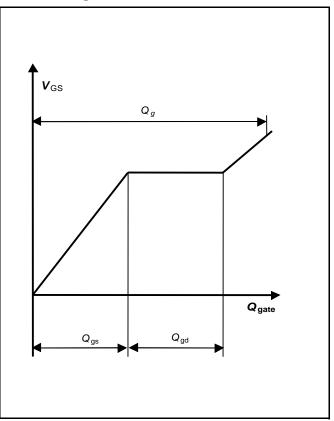
#### 14 Drain-source breakdown voltage



#### 15 Typ. gate charge

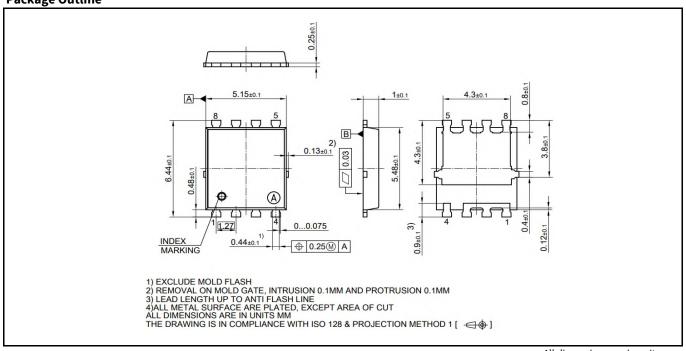


#### 16 Gate charge waveforms



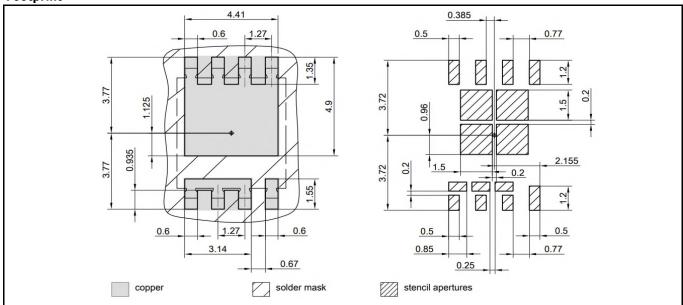


**Package Outline** 



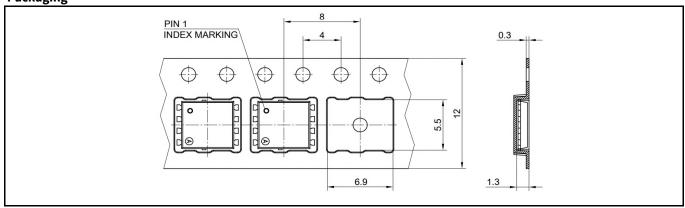
All dimensions are in units mm

#### **Footprint**



All dimensions are in units mm

#### **Packaging**



All dimensions are in units mm

IAUCN04S7L011



## **Revision History**

Revision	Date	Changes	
Revision 1.0	15.11.2023	Final Data Sheet	

#### Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

Edition 2023-11-15

Published by

**Infineon Technologies AG** 

81726 Munich, Germany

© 2023 Infineon Technologies AG

All Rights Reserved.

Do you have any questions about any aspect of this document?

Email: erratum@infineon.com

**Document reference** IAUCN04S7L011-Data-Sheet-10-Infineon

#### IMPORTANT NOTICE

regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications. The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

The information given in this document shall in no event be For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office (<u>www.infineon.com</u>).

#### WARNINGS

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact the nearest Infineon Technologies

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal